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High-Performance Data Processing Unit for Space Applications

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DSI Aerospace Technologie GmbH is an SME located in Bremen, Germany which provides following electronic equipment:





DSI-AS electronics equipment is part of major European airborne and space programs

S3Net (H2020)

EO Satellite Constellation Study

EDRS-C Satellite

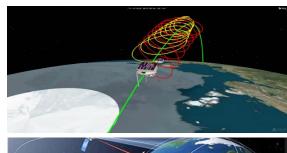
Ground crypto unit & key generation unit

JUICE CDMS SSMM

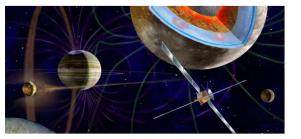
Solid state mass memory board

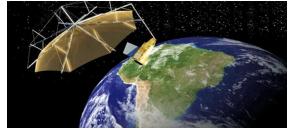
Biomass

Payload data handling unit









KACST Satellite Constellation

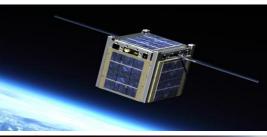
Satellite OBC with Mass Memory

MetOp-SG ICI

Command & data processing unit of the Ice Cloud Imager instrument

Hayabusa-II MASCOT On Board Computer

FLEX Payload data handling unit









High-Performance Data Processing Unit for Space Applications



Continuously rising demand for high-performance data processing in various space-applications

Non-Terrestrial-Networks

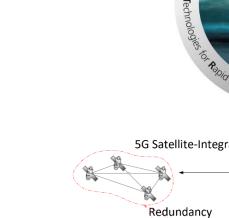
• Integration of satellite constellations

Explorer Missions

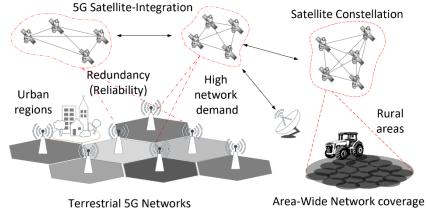
• Complex robotical tasks need to be carried out

Earth Observation

• Machine-Learning-based data processing







High-Performance Data Processing Unit for Space Applications

OBDP Workshop 2021



Key features

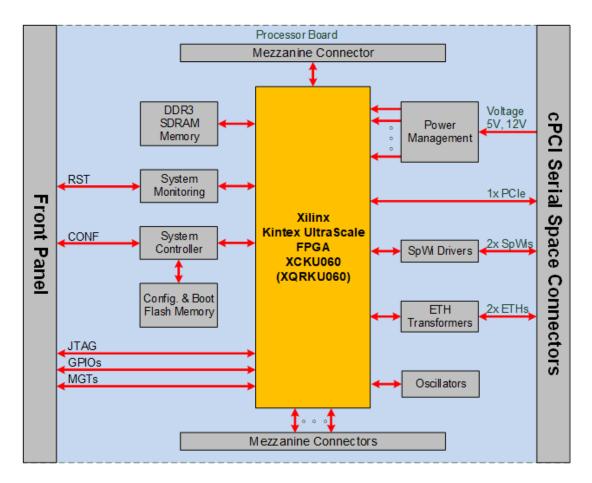
- Kintex UltraScale for Space Applications
- Various interfaces/communication protocols available

Interfaces

- Frontpanel: HSSL-based connectors
- Backplane: Compact PCI Serial Space (cPCI-SS)
- 2 Mezzanine connectors for expandability

Mechanical properties

- Form factor: 6U
- Mass: < 800g (without mezzanine extension)





The High-Performance Data Processing Unit (HPDPU)



OBDP Workshop 2021

High-Performance Data Processing Unit for Space Applications



The FPGA processing core

Xilinx Kintex Ultrascale device technology (20nm)

- 726k logic cells
- 2760 DSP slices
- 1080 BRAM Blocks
- High-speed transceivers (GTH)
- Full Xilinx design suite support

Variants

- Radiation Tolerant (XQRCU060)
- Commercial/NewSpace (XCKU060)
- (Almost) full footprint compatibility



Backplane connectors

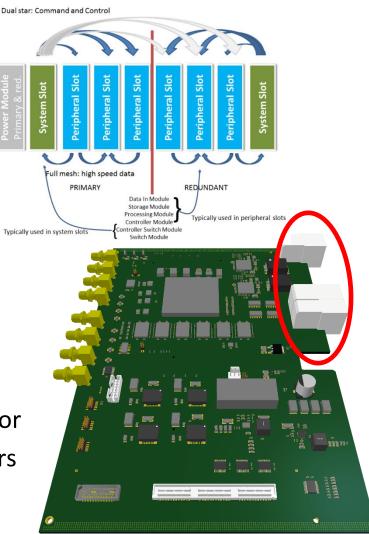


cPCI-SS backplane standard

- Robust and reliable standard
- Enables modular assembly of space electronics
- Fixed slot profiles/pin assignments
- Supports various interfaces,
 - 2 PCIe, 2 SpW, 2 Ethernet

FMC-based Mezzanine connectors

- 2 LPC connectors are used for the HPDPU
- 68 user-defined signals (34 differential pairs) per connector
- Enables integration of application-specific HW accelerators





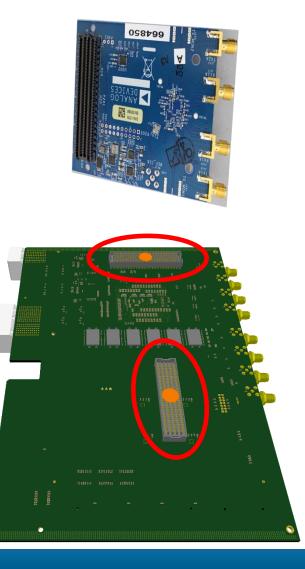


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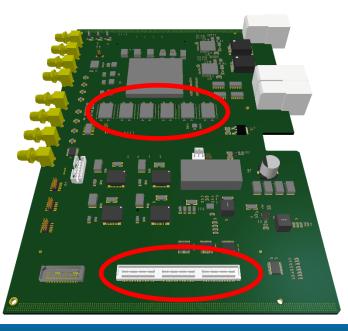
System Control

- External programming device and scrubber
- 256 MiByte NOR-Flash

Data Memory

- 8 GiByte SDRAM
- Up to 16MBps throughput
- 16-bit databus
- Fault-tolerance
 - *Reed-Solomon-based error correcting codes: RS(12,8)*





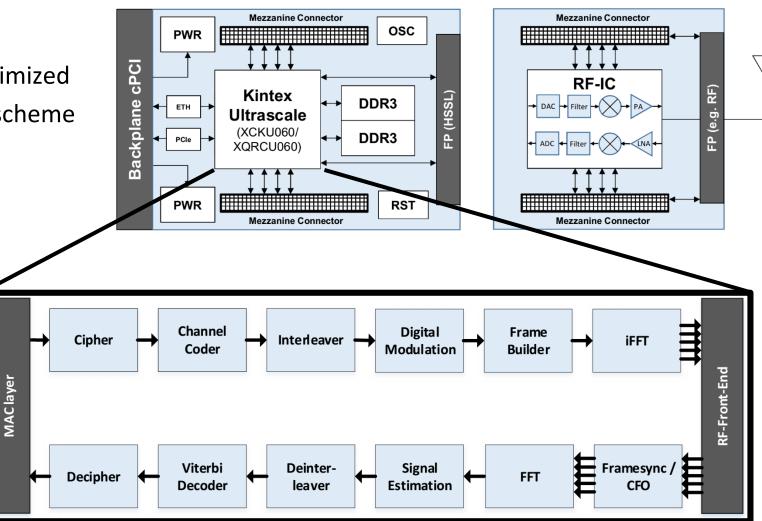


URC-oriented BBSP

- High-reliablility, latency optimized
- OFDM-based transmission scheme
- QPSK-based modulation
- Convolutional coder
- VHDL-based design

Implementation

- Logic/physical synthesis
- Strategy: balanced



High-Performance Data Processing Unit for Space Applications



Comparison to state-of-the-art FPGAs for space-applications

	Kintex Ultrascale	RTAX	RTG4	Artix-7	Zynq Ultrascale+
Device	XQRKU060/ XCKU060	4000D/DL	CG1657M	XC7A200	XCZU9EG
Technology [nm]	20	150	65	28	16
Logic Utilization [%]	14.04	320,59	52.00	38.41	16.98
DFF Utilization [%]	7.95	438.44	47,93	25.11	9.62
RAM Utilization [%]	3.15	11.67	28.88	12.74	3.73
DSP Utilization [%]	24.49	100.00	100.00	74.59	26.83
Power [W]	1.15	n/a	1.88	0.86	1.096
Radiation Tolerance	SEL immune up to 40 MeV/mg/cm ² , 100 Krad TID ^{\dagger}	SEL immune up to 95 MeV/mg/cm ² , 300 Krad TID	SEE immune up to LET 110 MeV/mg/cm ² , 100 Krad TID	No	No

These values are only valid for the space-qualified XQRKU060 Kintex device

\Rightarrow Very good results in terms of resource utilization and energy consumption



- HPDPU is a novel high-performance data processing unit for various space-applications
- EM will be available in Q3 2021
- A high-end Kintex Ultrascale FPGA is used which is available as radiation tolerant and commercial device
- The cPCI-SS backplane standard provides high re-usability while offering significant cost savings for future DHS
- The FMC mezzanine connector enables an easy integration of application-specific extensions, e.g. RFIC boards

The results highlight the HPDPU as a powerful working horse for next generation space applications

Thank you for your attention!

Questions?

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